

Technical Data Sheet

Reverse Package Chip LED

23-215A/BHC-DN2P2E/5A

Features

- Package in 8mm tape on 13" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-Free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 23-215A SMD Taping is much smaller than `lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Dowt No.	C	Resin Color	
Part No.	Material	Emitted Color	Kesin Color
23-215A/BHC-DN2P2E/5A	InGaN	Blue	Water Clear



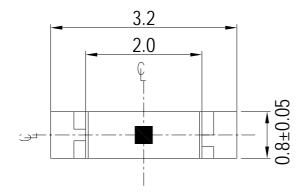
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 1 of 10

Device No.: DSE-235-002 Prepared date: 6-Mar-2007 Prepared by: Jay Chou

EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

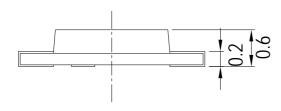
23-215A/BHC-DN2P2E/5A

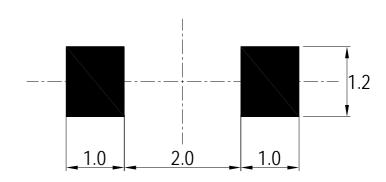
Package Outline Dimensions

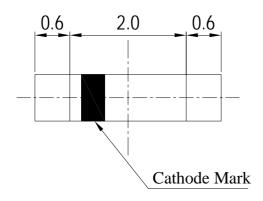




Recommed solder pad







Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd.

http://www.everlight.com

Rev. 2

Page: 2 of 10

Device No.: DSE-235-002

Prepared date: 6-Mar-2007

Prepared by: Jay Chou



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	${ m I}_{ m F}$	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA
Power Dissipation	Pd	110	mW
Electrostatic Discharge(HBM)	ESD	150	V
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$ C
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec Hand Soldering : 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

======================================							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	36		72	mcd		
Peak Wavelength	λp		468		nm		
Dominant Wavelength	λd	466		472	nm	IF 20 A	
Spectrum Radiation Bandwidth	Δλ		35		nm	IF=20mA	
Viewing Angle	2 θ 1/2		130		deg		
Forward Voltage	VF	2.75		3.65	V		
Reverse Current	IR			50	μ A	VR=5V	

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 3 of 10

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
	AA2	466	468			
D	AA3	468	470	nm	IF=20mA	
	AA4	470	472			

Bin Range Of Luminous Intensity

		<u> </u>		
Bin	Min	Max	Unit	Condition
N2	36	45		
P1	45	57	mcd	IF=20mA
P2	57	72		

Bin Range Of Forward Voltage

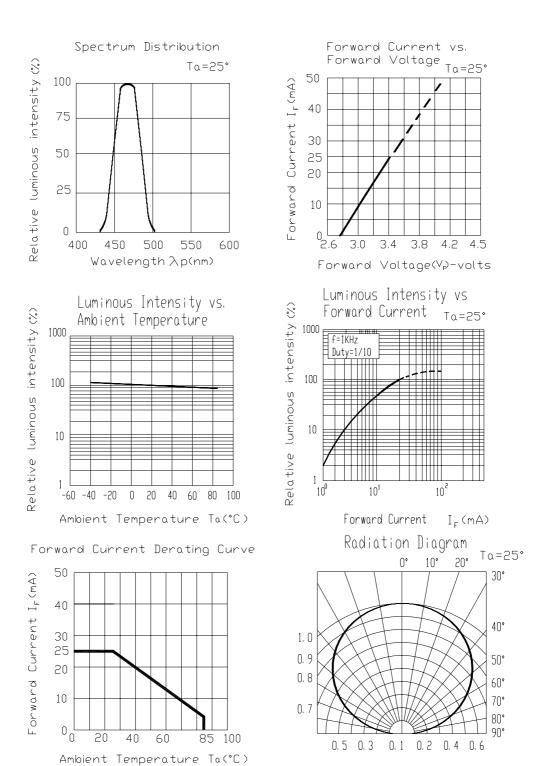
Group	Bin	Min	Max	Unit	Condition	
	5	2.75	3.05	V V		
Е	6	3.05	3.35		IF=20mA	
	7	3.35	3.65			

Notes:

- 1. Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 4 of 10

Typical Electro-Optical Characteristics Curves



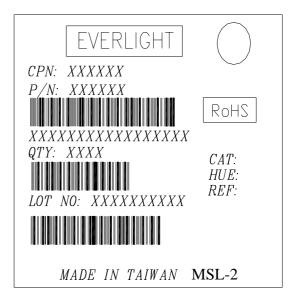
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 5 of 10 Device No.: DSE-235-002 Prepared date: 6-Mar-2007 Prepared by: Jay Chou

Label explanation

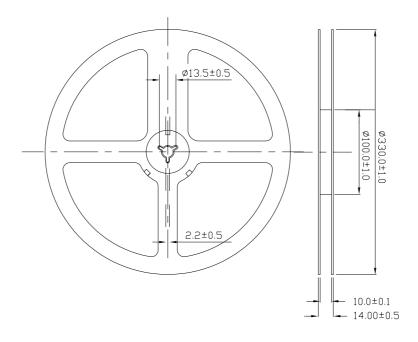
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



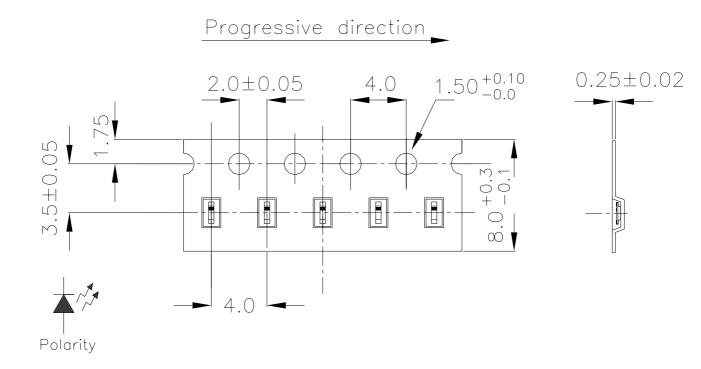
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

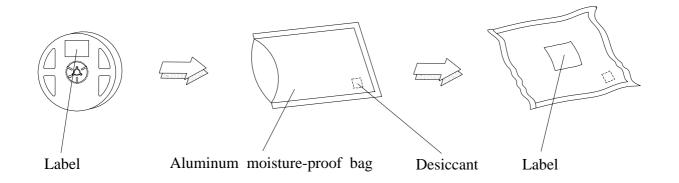
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 6 of 10 Device No.: DSE-235-002 Prepared date: 6-Mar-2007 Prepared by: Jay Chou

Carrier Tape Dimensions: Loaded quantity 5000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd.

http://www.everlight.com

Rev. 2

Page: 7 of 10

Device No.: DSE-235-002

Prepared date: 6-Mar-2007

Prepared by: Jay Chou



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 8 of 10

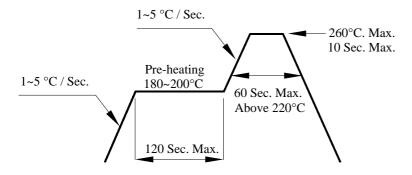
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 9 of 10 Device No.: DSE-235-002 Prepared date: 6-Mar-2007 Prepared by: Jay Chou

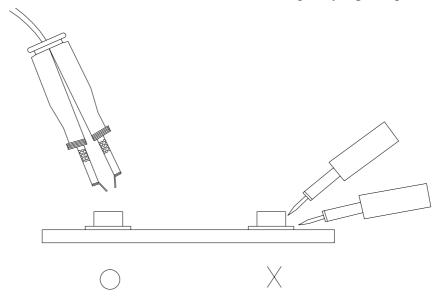


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 10 of 10